MDSdisplays.com

COB Technology

COB (Chips on Board)



SMD PROBLEM NOW ALSO FOR MINI PIXEL

EX: P1.25mm 0.64MILLION/M²

100PPM: WILL BE 64 LED LAMP Dead

PPM: Pixel Dead Per M2

Like the Right Side Picture



SMD PROBLEM NOW ALSO FOR MINI PIXEL

P1.25mm 0.64MILLION/M²

50PPM: WILL BE 32 LED LAMPS DEAD

PPM: Pixel Dead Per M2

Like the Right Side Picture



SMD SMALL PIXEL PROTECTION PROBLEM

> The lamp bead pad is too fragile, and the bumps in handling, installation

and use can easily damage the lamp bead;

> The slender mask is easily deformed by the influence of thermal

expansion and contraction during long-term use;

SMD SMALL PIXEL PROTECTION PROBLEM

Dust that penetrates into the mask and lamp gap during long-term use

cannot be cleaned;

> When the human body touches the screen in a dry environment, the

influence of static electricity can easily lead to the breakdown of the

lamp beads.

SMALL SMD PIXEL LIMITATIONS

Limitation of spacing size

- Bottleneck in cost price space
- Reliability and stability bottleneck
- Fragile hardware protection bottleneck

ADVATAGE OF COB

SUPER STABLE



ADVATAGE OF COB

SUPER PROTECTED



Impact resistance up to 50N / CM2



ADVATAGE OF COB

SUPER PROTECTED

NOT WATER PROOF

WATER PROOF







COB

Easy To Clean With Wet Cloth



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THANK YOU !

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